

Multilayer Ceramic Chip Capacitors

C3216C0G2J331K060AA



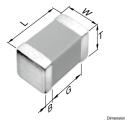






TDK item description C3216C0G2J331KT****

Applications	Commercial Grade	
Feature	Mid Mid Voltage (100 to 630V)	
Series	C3216 [EIA 1206]	
Status	Production (Not Recommended for New Design)	



	Size
Length(L)	3.20mm ±0.20mm
Width(W)	1.60mm ±0.20mm
Thickness(T)	0.60mm ±0.15mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	1.00mm Min.
Recommended Land Pattern (PA)	2.10mm to 2.50mm(Flow Soldering)
Recommended Land Fattern (FA)	2.00mm to 2.40mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.10mm to 1.30mm(Flow Soldering)
Necommended Land Factern (FB)	1.00mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PC)	1.00mm to 1.30mm(Flow Soldering)
neconfinenced Land Fattern (FC)	1.10mm to 1.60mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	330pF ±10%	
Rated Voltage	630VDC	
Temperature Characteristic	COG(0±30ppm/°C)	
Q (Min.)	1000	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Coldoring Mathod	Wave (Flow)
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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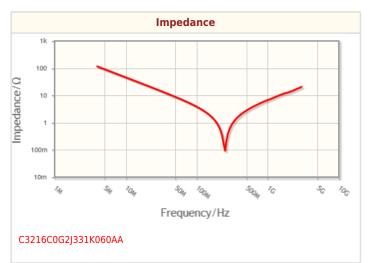




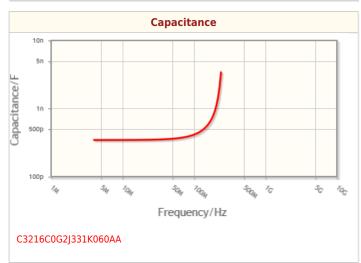


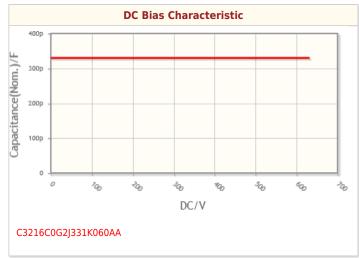


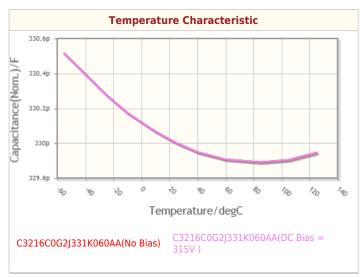
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)











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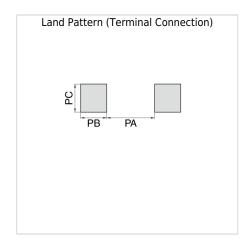








Associated Images



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